## INTEGRATED CIRCUITS

# DATA SHEET

## PCK2002PL 140 MHz PCI-X clock buffer

Preliminary specification





## 140 MHz PCI-X clock buffer

## PCK2002PL

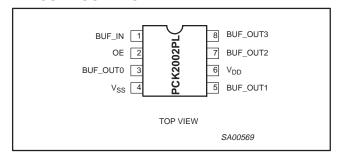
#### FEATURES

- General purpose and PCI-X 1:4 clock buffer
- 8-pin TSSOP 3 × 4.4 mm package
- Same form, fit, and function as CDCV304
- See PCK2001 for 48-pin 1:18 buffer part
- See PCK2001M for 28-pin 1:10 buffer part
- See PCK2001R for 16-pin 1:6 buffer part
- Operating frequency: 0 140 MHz
- Part-to-part skew < 500 ps
- Low output skew: <200 ps
- 3.3 V operation
- ESD classification testing is done to JEDEC Standard JESD22.
  Protection exceeds 2000 V to HBM per method A114.

#### **DESCRIPTION**

The PCK2002PL is a 1–4 fanout buffer used as a high-performance, low skew, general purpose and PCI-X clock buffer. It distributes one input clock (BUF\_IN) signal to four output clocks (BUF\_OUT\_n).

#### **PIN CONFIGURATION**



#### **PIN DESCRIPTION**

PIN NUMBER	I/O TYPE	SYMBOL	FUNCTION
1	Input	BUF_IN	Buffered clock input
3, 5, 7, 8	Output	BUF_OUT (0-3)	Buffered clock outputs
6	Input	$V_{DD}$	3.3 V supply
2	Input	OE	Output Enable
4	Input	V <sub>SS</sub>	Ground

#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay BUF_IN to BUF_OUT <sub>n</sub>	$V_{CC} = 3.3 \text{ V, } C_L = 25 \text{ pF}$	2.9 2.8	ns
t <sub>r</sub>	Rise time	$V_{CC} = 3.3 \text{ V}, C_L = 25 \text{ pF}, 0.2 V_{DD} \text{ to } 0.6 V_{DD}$	800	ps
t <sub>f</sub>	Fall time	$V_{CC} = 3.3 \text{ V}, C_L = 25 \text{ pF}, 0.6 V_{DD} \text{ to } 0.2 V_{DD}$	600	ps
I <sub>CC</sub>	Total supply current	V <sub>CC</sub> = 3.6 V	50	μΑ

#### **ORDERING INFORMATION**

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DRAWING NUMBER
8-Pin Plastic TSSOP	−40 to +85 °C	PCK2002PLDP	SOT530-1

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## **FUNCTION TABLE**

OE	BUF_IN	BUF_OUTn
L	Х	L
Н	L	L
Н	Н	Н

## ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to  $V_{SS}$  ( $V_{SS}$  = 0 V).

CVMDOL	DADAMETED	CONDITION	LIN		
SYMBOL	PARAMETER	CONDITION	MIN	MAX	UNIT
$V_{DD}$	DC 3.3 V supply voltage		-0.5	+4.3	V
I <sub>IK</sub>	DC input diode current	V <sub>1</sub> < 0	_	-50	mA
VI	DC input voltage	Note 2	-0.5	V <sub>DD</sub> + 0.5	V
I <sub>OK</sub>	DC output diode current	$V_O > V_{DD}$ or $V_O < 0$	_	±50	mA
Vo	DC output voltage	Note 2	-0.5	V <sub>DD</sub> + 0.5	V
I <sub>O</sub>	DC output source or sink current	$V_O \ge 0$ to $V_{DD}$	_	±50	mA
T <sub>stg</sub>	Storage temperature range		-65	+150	°C
P <sub>tot</sub>	Power dissipation per package plastic medium-shrink SO (SSOP)	For temperature range: 0 to +70 °C above +55 °C derate linearly with 11.3 mW/K	_	850	mW

#### NOTES:

## **RECOMMENDED OPERATING CONDITIONS**

CVMPOL	DADAMETED	CONDITIONS	LIM	UNIT	
SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNII
$V_{DD}$	DC 3.3V supply voltage		3.0	3.6	V
C <sub>L</sub>	Capacitive load		20	30	pF
V <sub>I</sub>	DC input voltage range		0	$V_{DD}$	V
V <sub>O</sub>	DC output voltage range		0	$V_{DD}$	V
T <sub>amb</sub>	Operating ambient temperature range in free air		-40	+85	°C

<sup>1.</sup> Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>2.</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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## DC CHARACTERISTICS

			LIM	ITS			
SYMBOL	PARAMETER		TEST CONDITIONS	T <sub>amb</sub> = -40	UNIT		
		V <sub>DD</sub> (V)	OTHER		MIN	MAX	] [
V <sub>IH</sub>	HIGH level input voltage	3.0 to 3.6	_	_	2.0	V <sub>DD</sub> + 0.3	V
V <sub>IL</sub>	LOW level input voltage	3.0 to 3.6	_	_	V <sub>SS</sub> - 0.3	0.8	V
		3.0 to 3.6	I <sub>OH</sub> = -1 mA	_	V <sub>DD</sub> - 0.2	_	V
V <sub>OH</sub>	Output HIGH voltage	3.0	I <sub>OH</sub> = -24 mA	_	2.0	_	V
		3.0	I <sub>OH</sub> = −12 mA	_	2.4	_	V
		3.0 to 3.6	I <sub>OL</sub> = 1 mA	_	_	0.2	V
V <sub>OL</sub>	Output LOW voltage	3.0	I <sub>OL</sub> = 24 mA	_	_	0.8	V
		3.0	I <sub>OL</sub> = 12 mA	_	_	0.55	V
	Outrot HIGH comment	3.0	V <sub>OUT</sub> = 1 V	_	-50	_	mA
Іон	Output HIGH current	3.3	V <sub>OUT</sub> = 1.65 V	_	_	-150	mA
	Outrot LOW surrout	3.0	V <sub>OUT</sub> = 2.0 V	_	60	_	mA
l <sub>OL</sub>	Output LOW current	3.3	V <sub>OUT</sub> = 1.65 V	_	_	150	mA
±I <sub>I</sub>	Input leakage current	3.6	$V_I = V_{DD}$ or GND	_	_	±5	μΑ
I <sub>CC</sub>	Quiescent supply current	3.6	$V_I = V_{DD}$ or GND	I <sub>O</sub> = 0	_	100	μΑ

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#### **AC CHARACTERISTICS**

SYMBOL	PARAMETER	TEST CONDITI	T <sub>aml</sub>	UNIT			
			NOTES	MIN	TYP <sup>6</sup>	MAX	
T <sub>H</sub>	CLK HIGH time	66 MHz	2	6.0		_	ns
TL	CLK LOW time	OO WITZ	3	6.0	_	_	ns
T <sub>H</sub>	CLK HIGH time	140 MHz	2	2.9	_	_	ns
TL	CLK LOW time	140 MHZ		3.0	_	_	ns
T <sub>R</sub>	Output rise slew rate		4	1.4	1.7	4.0	V/ns
T <sub>F</sub>	Output fall slew rate		4	1.5	2.2	4.0	V/ns
T <sub>PLH</sub>	Buffer LH propagation delay		5	1.8	2.9	3.4	ns
T <sub>PHL</sub>	Buffer HL propagation delay		5	1.8	2.8	3.4	ns
T <sub>SKW</sub>	Bus CLK skew		1		_	200	ps
T <sub>DDSKW</sub>	Device to device skew		1	_	_	500	ps

## NOTES:

- 1. CLK skew is only valid for equal loading of all outputs.
- T<sub>H</sub> is measured at 0.5 V<sub>DD</sub> as shown in Figure 2.
  T<sub>L</sub> is measured at 0.35 V<sub>DD</sub> as shown in Figure 2.
- 4. T<sub>R</sub> and T<sub>F</sub> are measured as a transition through the threshold region 0.2 V<sub>DD</sub> to 0.6 V<sub>DD</sub> and 0.6 V<sub>DD</sub> to 0.2 V<sub>DD</sub>.
  5. Input edge rate for these tests must be faster than 1 V/ns.
- 6. All typical values are at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.

## **AC WAVEFORMS**

 $V_M = 50\% V_{DD}$ 

 $C_{L}^{...} = 25 \text{ pF}$ 

 $\bar{V_{OL}}$  and  $\bar{V}_{OH}$  are the typical output voltage drop that occur with the output load.

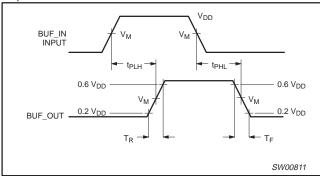


Figure 1. Load circuitry for switching times.

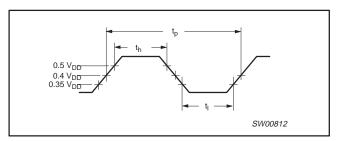


Figure 2. Buffer Output clock

## **TEST CIRCUIT**

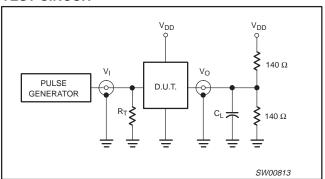


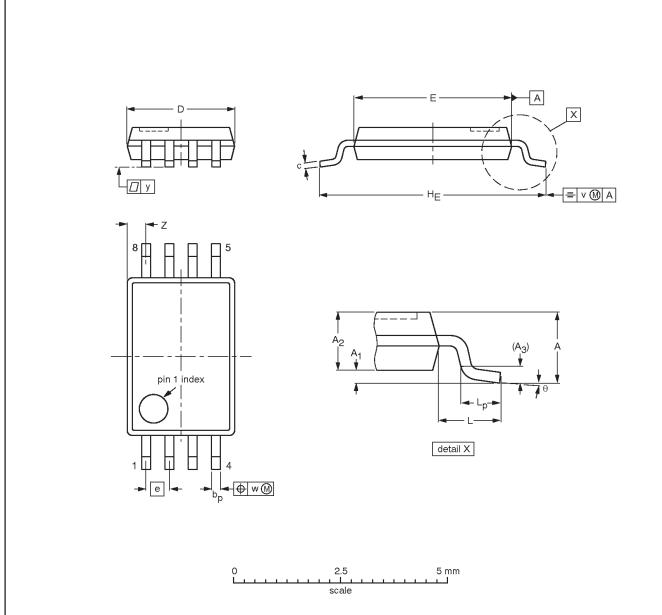
Figure 3. Load circuitry for switching times

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## TSSOP8: plastic thin shrink small outline; 8 leads; body width 4.4 mm

SOT530-1



## DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	C	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	>	w	у	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.85	0.25	0.30 0.19	0.20 0.13	3.10 2.90	4.50 4.30	0.65	6.50 6.30	0.94	0.70 0.50	0.10	0.10	0.10	0.70 0.35	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE						ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT530-1		MO-153				<del>-99-12-27</del> 00-02-24

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**NOTES** 

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#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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